Details Page 1 of 1

Back to list of product families

Product group:

Heatsinks and active heatsinks for processors > Heatsinks for LEDs

Heatsinks for LEDs / ICK LED R 28 x 15 G 🛒 🚭 🖂



Ø 28 x 15 mm, for IC design LED

Parameters of article ICK LED R 28 x 15 G

R_{th} [K/W]

(i) 15.72

dissipation loss [W]

7.6

mounting method

therm. conductive foil / therm. cond. adhesive

socketuniversalsuitable for processor typeuniversal

Ø [mm]þeigth [mm]15.24plate thickness [mm]3.5

plate thickness [mm] 3.5 surface treatment black anodised

Sairace treatment black and

Technical Drawing

Accessories/ related articles

Thermally conductive foil both sides adhesive / WLFT 404 D 28 Thermally conductive foil both sides adhesive / WLFT 405 D 28 $^{\circ}$

Download CAD Drawing





igs.